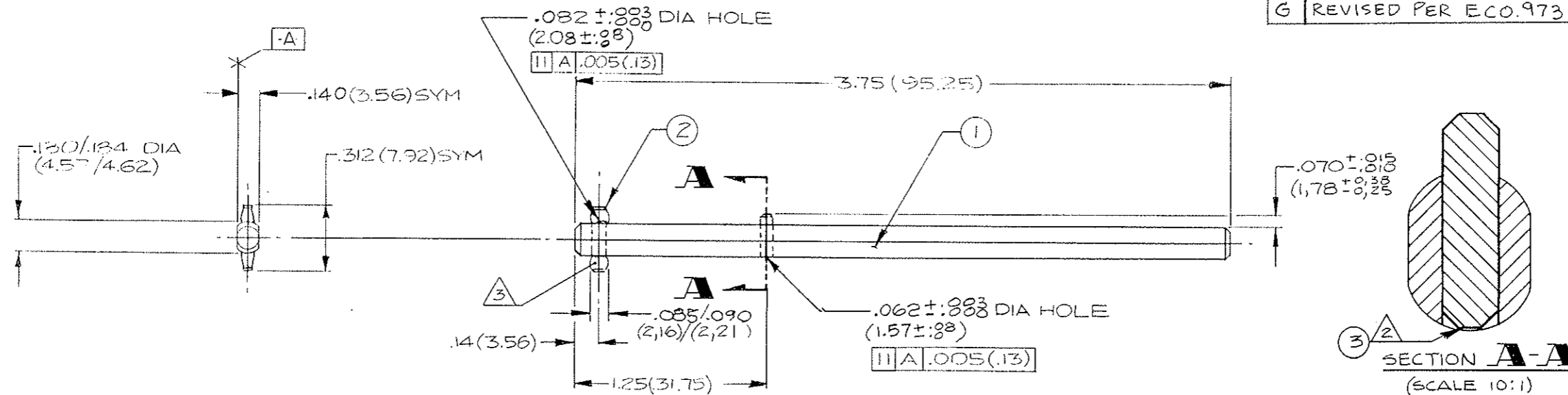


ZIF ROD SUB-ASSEMBLY	
PART NO.	MFG DWG
ZIR-07-E06B	252506-10

REVISED ON DWG		REVISIONS		
SYM	DESCRIPTION	DATE	APPROVAL	
A	.312 DIM WAS .375 (.062 WAS .078 (CUST. REQUEST))	5-17-82	MMH	
B	MODIFIED FINISH SPECS.	6-16-82	HHS	
C	REVISED PER E.O. #1208 + 1209	10-13-82	KAL	
D	REVISED PER E.O. #1243	1-2-83	EBL	
E	REVISED PER E.O. #1331	6-17-83	EBL	
F	REVISED PER E.O. #1421	9/20/83	EBL	
G	REVISED PER E.O. 973	9-21-09	N.KEENA	



NOTES:

- 1. NO MARKING ON PART. PACKAGING IDENTIFIED WITH APPLICABLE PART NO.
- 2. PIN TO BE FLUSH WITH ROD $\pm .015$
- PIN CRIMPED TO ASSURE RETENTION IN ROD.
- 3. STANDARD FINISH AS SHOWN. ALTERNATE FINISH: UNPLATED. DELETE LETTER "B" & ADD "U" TO PART NO. (EX: ZIR-07-E06U, ZIRO-07-E06U).

PART	COMPONENT	ITEM	REQ'D	DESCRIPTION	FINISH
ZIF ROD SUB-ASSEMBLY	ANTI-ROTATION PIN	3	1	.062 ± .001 (1.57 ± .03) DIA W/.003 (.08) KNURL, STAINLESS STEEL	PASSIVATE PER MIL-F-14072 (E 300)
	ACTUATOR PIN	2	1	.082 ± .001 (2.08 ± .03) DIA W/.003 (.08) KNURL, STAINLESS STEEL	
	ROD	1	1	ALUMINUM ALLOY	BLACK ANODIZE PER MIL-A-8625 TYPE II, CLASS 2

LIST OF MATERIAL

UNLESS OTHERWISE SPECIFIED		DRAFTSMAN	DATE	ZIF ROD SUB-ASSEMBLY (SPECIAL)	 INTERNATIONAL ELECTRONIC RESEARCH CORPORATION A Corporate Division of Dynamics Corporation of America Burbank, California 91501
DIMENSIONS IN PARANtheses ARE IN MILLIMETERS & APPLY AFTER PLATING.		E.P. LONG	1-11-82		
DIMENSIONS IN INCHES		CHECKER	2/1/82		
APPLICABLE TOL. IN M/M		ENGINEER	3/1/82		
FRACTIONAL	±.4	INSPECTION	1/1/82	DRAWING NUMBER 252506	REV G
.XX	±.25	PRODUCTION	1/1/82		
.XXX	±.13	APPROVED	2/1/82		
UNLESS OTHERWISE SPECIFIED --- DIMENSIONS APPLY AFTER PLATING		TOLERANCES		SCALE 2:1	SEEDS
FRACTIONAL	±.154	XX	±.010	CODE 98978	INDEX "B"
ANGLES	± 1/2°	XXX	±.008		
SURFACE					

PRODUCT DISCLOSED HEREON IS COVERED BY U.S. PATENT 3,275,905

OWNED BY INTERNATIONAL ELECTRONIC RESEARCH CORP.

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